<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: XX####</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 7/3/2014 3:54:26 PM</td>
<td>TEXAS INSTRUMENTS</td>
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